ISO/TTA 6:2007-10 (E)

Code of practice for creep/fatigue testing of cracked components

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Contents

Page

1 EXECUTIVE SUMMARY 1

2 SCOPE 1

3 SPECIFIC OBJECTIVES 2

4 INTRODUCTION 2
4.1 Background to VAMAS Creep Crack Growth Initiatives 3
4.2 Background to Industrial needs for validated Test Data 3
4.3 Relevance of Testing Methods to Life Assessment Codes 4
4.3.1 Background to Life Assessment Codes 4
4.3.2 Relation between laboratory tests and Component Assessment Codes 5
4.3.3 Factors involved in the development of assessment codes 5
4.4 Requirements for the VAMAS TWA 25 CoP 6
4.5 ISO requirements 6
4.5.1 ISO Technology Trend Assessment (ISO/TTA) 7

5 Acknowledgements 7
5.1 List of participants in VAMAS TWS25 7

6 NOMENCLATURE AND ABBREVIATIONS 8
6.1 Nomenclatures 8
6.2 Listing of abbreviations 9

7 DESCRIPTION OF CREEP AND FATIGUE CRACKING 10
7.1 Failure due Creep Crack Growth (CCG) 10
7.2 Creep Crack Initiation (CCI) 10
7.3 Transient crack growth conditions 10
7.4 Steady state Creep Cracking (CCG) 10
7.5 Fatigue and Creep/Fatigue Crack Growth (FCG and CFCG) 11
7.5.1 Failure due to fatigue 11
7.5.2 Creep/Fatigue interaction 11
7.6 Factors affecting CCI, CCG and CFCG 11
7.6.1 Creep properties 11
7.6.2 Metallurgical effects 12
7.6.3 Presence of residual stress fields 12
7.6.4 Aggressive environments 12
7.6.5 Anisotropic and inhomogeneous material characteristics 12

8 TEST METHODS 13
8.1 Overview 13
8.2 Test Geometries 13
8.3 Experimental Test Methods 14
8.3.1 Material procurement 14
8.3.2 Specimen selection 14
8.3.3 Crack-plane orientation 14
8.3.4 Specimen machining 14
8.3.5 Specific size requirements 15
8.3.6 Specific side-grooving requirements 15
8.3.7 Shape of the crack front 15
8.3.8 Pre-cracking to introduce a sharp flat crack front 15
8.3.9 Pre-cracking for CCI tests 15
8.3.10 Crack length measurements 16
8.3.11 The use of Potential Drop (PD) 16
8.3.12 Preparing the specimens for PD leads 16
8.3.13 Specimen setup 16

8.3.14 Loading and creep displacement measurements 16
8.3.15 Displacement gauge 17
8.3.16 Heating of the specimens 17
8.3.17 Initial pre-load 17
8.3.18 Monitoring the temperature 17
8.3.19 Unplanned temperature excursions 17
8.3.20 Initial pre-load 18
8.3.21 Specimen loading 18
8.4 Data Collection 18
8.4.1 Detailed test and data monitoring 18
8.4.2 Data logging 18
8.4.3 Displacement measurements 18
8.5 Post-Test Measurements 19
8.5.1 Measurement of the final crack front 19
8.5.2 Crack tip bowing 19
8.5.3 Crack extension criteria 19
8.5.4 Crack deviation criteria 19
8.6 Recommended Minimum Number and Duration for Tests 20
8.6.1 Batch to batch variability 20
8.6.2 Minimum test requirements 20
8.6.3 Single point data per test 21
8.6.4 Multiple points data per test 21
8.6.5 Test duration requirements 21
8.7 Sensitivity and Accuracy Limits of the Results 21
8.7.1 Effects of data variability on correlation for FCG, CCG and CCI 21
8.8 Preparation of Test Data 22
8.8.1 Data collection 22
8.8.2 Time at which the test should be stopped 22
8.8.3 Smoothing the PD output data 22
8.8.4 Deriving the crack length from the PD output 22
8.8.5 Recommended number of data points 23
8.8.6 Calculating cracking and displacement rates 23

9 DATA ANALYSIS PROCEDURES 23
9.1 Choosing an appropriate CCI or CCG rate Correlating Parameter 23
9.1.1 Choice of parameter for correlating CCG 23
9.1.2 Choice of the C* term for CCG rate 23
9.1.3 Choice of parameter for CCI 24
9.2 Definitions for the relevant Fracture Mechanics Parameters 24
9.2.1 Stress intensity factor, K 24
9.2.2 J-integral 24
9.2.3 The C* parameter 24
9.2.4 Creep zone 25
9.2.5 Steady state creep 25
9.2.6 The C_t parameter 26
9.2.7 Small-scale creep 26
9.2.8 Interpretation of C* parameter 26
9.2.9 Time Dependant Failure Assessment Diagram (TDFAD) for CCI 26
9.2.10 The Q* Parameter 27
9.3 Criteria for Validity Checks of *C* and K* 27
9.3.1 Check for validity of C* 27
9.3.2 Components of displacement rates 27
9.3.3 Validity criteria for C* for highly ductile materials 28
9.3.4 Validity criteria for creep brittle materials 29
9.3.5 Transition time criteria for C* 29

10 REPORTING PROCEDURES 30
10.1 Details of test information to be reported 30
10.1.1 Report of findings 30
10.1.2 Pedigree of the material 30
10.1.3 Material properties to be logged 30

10.1.4 Test machine description 30
10.1.5 Details of starter crack 30
10.1.6 Details for loading 30
10.1.7 Report of data analysis 30
10.1.8 Plots of data 31
10.1.9 Tabulation of results 31
10.1.10 Photographic/micrographic evidence 31
10.1.11 Treatment of anomalous data 31

11 CORRELATING CRACK GROWTH USING FRACTURE MECHANICS 31
11.1 CCG rate analysis 31
11.2 Crack Initiation (CCI) Analysis 32
11.3 FCG rate Analysis 32
11.4 Creep/fatigue crack growth rate analysis 33

12 Methods for Calculating the C^* Parameter 33
12.1 Experimental Estimates of C^* 33
12.2 Reference Stress Method of Estimating C^* 34

13 APPENDIX I 36
13.1 Test Specimen Geometries 36
13.2 Geometry Definitions for Laboratory Specimens 36

14 SPECIMEN FRACTURE MECHANICS PARAMETER SOLUTIONS 38
14.1 Stress Intensity Factor K 38
14.2 Solutions for the Y function 38
14.2.1 Y factor for C(T) 39
14.2.2 Y factor for CS(T) 39
14.2.3 Y factor for for SEN(T) 39
14.2.4 Y factor for SEN(B) (3 Point Bend Specimen) 39
14.2.5 Y factor for DEN(T) 40
14.2.6 Y factor for M(T) 40
14.3 C^* Solutions 40
14.4 Reference Stress (σ_{ref}) Solutions 41
14.4.1 σ_{ref} for C(T) 41
14.4.2 σ_{ref} for CS(T) 42
14.4.3 σ_{ref} for SEN(T) 42
14.4.4 σ_{ref} for SEN(B) (3 Point Bend Specimen) 42
14.4.5 σ_{ref} for DEN(T) 42
14.4.6 σ_{ref} for M(T) 43
14.5 η Functions for cracked geometries 43
14.5.1 Nomenclature (see Figure A.1.3) 43
14.5.2 Solutions for creep crack growth parameter, C* 44
14.5.3 Best fit solutions of η from finite element calculations 45
14.5.4 Choice of η for evaluating C* for material CCI and CCG properties 45
14.5.5 Choice of η for evaluating C* in life assessment 45
14.6 η Function Equations 46
14.6.1 η functions for C(T) 46
14.6.2 η functions for CS(T) 46
14.6.3 η functions for SEN(T) 46
14.6.4 η functions for SEN(B) — 3PB 47
14.6.5 η functions for DEN(T) 47
14.6.6 η functions for M(T) 47
14.7 Table for η^{LLD} 49
14.8 Table for η^{CMOD} 50
14.9 Geometry Definitions for 'Feature' Type Specimens 51
14.9.1 Details form Pipe, Plate and Notched bar 'feature specimens' 51
14.10 Fracture Mechanics Functions for Feature Components 52
14.10.1 K solutions for pipes and plates 52
14.10.2 Reference stress solutions for pipes 53
14.10.3 Reference stress solutions for plates 53

14.10.4 Stress intensity factor K for the round notch bar 54
14.10.5 C* parameter for the notched bar....54

15 APPENDIX II :(TDFAD) K_{mat}^{c} approach for CCI....55
15.1 Introduction....55
15.2 Nomenclature....55
15.3 Failure Assessment Diagram....56
15.4 Materials Data Requirements....57

16 APPENDIX III: The Q* Parameter....61
16.1 Symbols and Designations....61
16.2 Scope....62
16.3 Specimen Geometry....62
16.4 Guideline for Calculation of the *Q** parameter....62
16.4.1 Crack Growth Analysis....62
16.4.2 Crack initiation Analysis....63

17 APPENDIX IV: Local CTOD Approach....64
17.1 Crack Tip Opening Displacement (CTOD)....64

18 APPENDIX V: Further Detailed Advice on Testing....66
18.1 Advice on Testing and Machine Specification....66
18.2 Loading Machine....66
18.3 Machine Tolerances....66
18.4 Grips....66
18.5 Alignment....66
18.6 Specimen Dimensional Measurement....67
18.7 Specimen Preparation....67
18.8 Permissible Temperature Deviation....67
18.9 Temperature Hold-time before start of Test....67
18.10 Thermocouple Junction and Wiring....67
18.11 Thermocouple Attachment....68
18.12 Verification of Thermocouple....68
18.13 Application of Load....68
18.14 Loading Precautions....68
18.15 Displacement Measurement....68
18.16 Apparatus for Crack Size Measurement....69
18.17 Potential Difference (PD) Performance....69
18.18 Specimen Preparation for Electric Potential Measurement....69
18.19 Premature Test Failure....69
18.20 Recommended Method for Treating Extensive Plasticity....69
18.21 Recommended Data Reduction Techniques....70
18.21.1 Calculating the cracking and displacement rates....70
18.21.2 Method for calculating the cracking and displacement rates....70
18.21.3 Secant method for deriving CCG and displacement rates....70
18.21.4 Incremental polynomial method to derive CCG and displacement rates....70
18.21.5 Calculating crack length....71
18.21.6 Voltage versus crack length relation....71

19 REFERENCES – Related International Standards and Codes....72

20 REFERENCES – Relevant Publications....74